

### General Description

The 85N03A uses advanced trench technology to provide excellent RDS(ON). This device is suitable for use as a wide variety of applications.

### Features

- Low On-Resistance
- 100% avalanche tested
- High Current Capability
- RoHS Compliant

### Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	30	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D@T_C=25^\circ C$	Continuous Drain Current, VGS @ 10V	85	A
$I_D@T_C=100^\circ C$	Continuous Drain Current, VGS @ 10V	60	A
$I_{DM}$	Pulsed Drain Current <sup>1</sup>	255	A
EAS	Single Pulse Avalanche Energy <sup>2</sup>	100	mJ
$P_D@T_C=25^\circ C$	Total Power Dissipation	65	W
$T_{STG}$	Storage Temperature Range	-55 to 175	$^\circ C$
$T_J$	Operating Junction Temperature Range	-55 to 175	$^\circ C$

### Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-ambient (PCB Mount) <sup>3</sup>	---	50	$^\circ C/W$
$R_{\theta JC}$	Thermal Resistance Junction -Case <sup>4</sup>	---	2	$^\circ C/W$

### Product Summary

BVDSS	RDSON	ID
30V	6m $\Omega$	85A

### Applications

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

### TO-252/251 Pin Configuration



### Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	30	---	---	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS}=10V, I_D=12A$	---	---	6	m $\Omega$
		$V_{GS}=4.5V, I_D=10A$	---	---	9	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	1	---	3	V
$I_{DSS}$	Drain-Source Leakage Current	$V_{DS}=24V, V_{GS}=0V, T_J=25^\circ\text{C}$	---	---	1	uA
		$V_{DS}=24V, V_{GS}=0V, T_J=125^\circ\text{C}$	---	---	150	
$I_{GSS}$	Gate-Source Leakage Current	$V_{GS} = \pm 20V, V_{DS}=0V$	---	---	$\pm 100$	nA
$g_{fs}$	Forward Transconductance	$V_{DS}=10V, I_D=10A$	---	15	---	S
$R_g$	Gate Resistance	$V_{DS}=0V, V_{GS}=0V, f=1\text{MHz}$	---	2.4	---	$\Omega$
$Q_g$	Total Gate Charge	$V_{DS}=15V, V_{GS}=4.5V, I_D=20A$	---	15	---	nC
$Q_{gs}$	Gate-Source Charge		---	4.2	---	
$Q_{gd}$	Gate-Drain Charge		---	7	---	
$T_{d(on)}$	Turn-On Delay Time	$V_{DD}=15V, V_{GS}=10V, R_G=10\Omega, I_D=20A$	---	12	---	ns
$T_r$	Rise Time		---	80	---	
$T_{d(off)}$	Turn-Off Delay Time		---	48	---	
$T_f$	Fall Time		---	35	---	
$C_{iss}$	Input Capacitance	$V_{DS}=15V, V_{GS}=0V, f=1\text{MHz}$	---	2000	---	pF
$C_{oss}$	Output Capacitance		---	450	---	
$C_{rss}$	Reverse Transfer Capacitance		---	100	---	

### Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_S$	Continuous Source Current		---	---	85	A
$V_{SD}$	Diode Forward Voltage	$V_{GS}=0V, I_S=30A, T_J=25^\circ\text{C}$	---	---	1.3	V

Note :

1. Single pulse width limited by junction temperature  $T_{J(MAX)}=150^\circ\text{C}$  .
2. Starting  $T_J=25^\circ\text{C}$  ,  $L=0.5\text{mH}$  ,  $V_{DD}=20V$  ,  $I_{AS}=20A$  .
3. When mounted on 1" square PCB (FR-4 or G-10 Material).
4.  $R_{\theta}$  is measured at  $T_J$  approximately at  $90^\circ\text{C}$  .

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